

PRODUCT NUMBER  
73347-Y04XXLF

RoHS COMPATIBLE  
SEE NOTE 5

PACKAGING OPTION LETTER  
SEE NOTE 4

SIZE: 2x2 POSITIONS

PLATING

1 = 0.76µm GOLD/GXT ON CONTACT AREA  
2µm MIN MATT TIN ON TAIL

7 = 0.76µm GOLD/GXT FULL PLATED

1.27µm MINIMUM NICKEL UNDERPLATING

NOTES :

1. MATERIAL HOUSING: HIGH TEMP. THERMOPLASTIC  
UL 94V-0, COLOR CREAM

2. MATERIAL TERMINAL: COPPER ALLOY

3. 7N MIN. PIN RETENTION IN EITHER DIRECTION.

4. PACKAGING :

= PACKAGING IN POLYBAGS

TR = PACKAGING IN TAPE & REEL, WITH  
PICK-UP CAP

5. RoHS COMPATIBLE PRODUCT SPECIFICATIONS

a - PLATING:

- "LF" MEANS THE PRODUCT IS LEAD-FREE,  
2µm MINIMUM MATTE TIN OVER 1.27µm  
MINIMUM NICKEL UNDERPLATE.

b - MANUFACTURING PROCESS COMPATIBILITY

- THE HOUSING WILL WITHSTAND EXPOSURE TO  
260°C PEAK TEMPERATURE FOR 30 SECONDES  
MAX IN A CONVECTION, INFRA-RED OR VAPOR  
PHASE OR REFLOW OVEN.

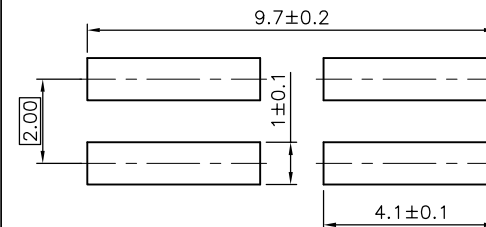
c - LABELLING:

- MEETS PACKAGING SPECS AS PER GS-14-920

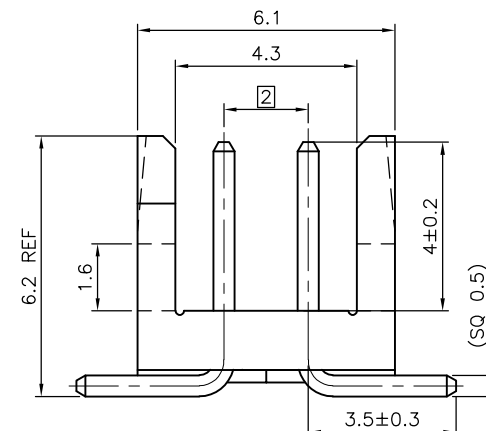
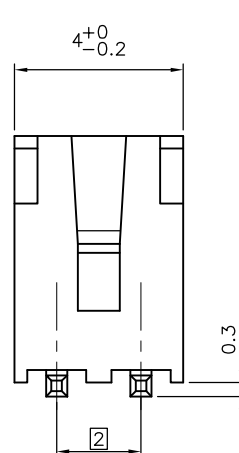
d - THIS PRODUCT MEETS EUROPEAN DIRECTIVES  
AND OTHER COUNTRY REGULATIONS AS DISCRIBED  
IN GS-47-0004.

6. PIN POS 1 RECOMMENDED ON THIS SIDE TO MATCH WITH  
HOUSING CODING.

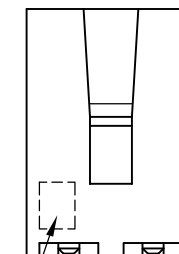
PICK UP CAP FOR "TR" PACKAGING



RECOMMENDED PAD LAYOUT



NOTE 6



mat'l. code				surface			tolerance			projection		product family	
SEE NOTES				ISO 1302			ISO 406			101		MINITEK HEADER	
ltr	ecn no	dr	date	tolerances unless otherwise specified								title	
K	B-19190	LMU	14.10.24	angles						mm		MINITEK	
L	F-36044	DDE	20.02.14	linear						scale 6:1		HEADER 2x2	
F	F07-0191	JCO	07.09.05	dr	J.COMPAGNON	97.11.25						dwg no	sheet 1 of 1 size
G	F08-0145	ELA	15.04.08	engr								73347	A3
H	F11-0078	LMU	11.06.29	chr									
J	F12-0019	JCO	12.02.27	appd	JMC	98.03.20						type	CUSTOMER Drawing
sheet	revision												
index	sheet												

# Mouser Electronics

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